

Better Radial Velocity Measurement Precision Through Organic Chemistry: The GMT Consortium Large Earth Finder (G-CLEF)

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G-CLEF in Eight Slides



G-CLEF on the **GMT**



The PRV Pupil Slicer/Fiber Feed





- Pupil Slicing is needed to get to R=108,000
- We treat the GMT as 7 x 8.4 m telescopes











The Echellogram



G-CLEF is the first major instrument for the GMT First light is in 2028 The Spectrograph passed CDR Dec 2018

Some Innovations in the G-CLEF Design

Measuring Pixel-to-Pixel Variations





The mechanical stability of the spectrograph optics is paramount for a stable wavelength scale.

Time-varying thermal gradients flex and distort the the position and shape of optics.

Plan A: Keep the optomechanics, especially the optical bench thermally stable.

Plan B: Make everything, especially the optical bench out of material with the lowest possible coefficient of thermal expansion (CTE) material possible.

Most previous optical benchs were made of mild steel - cheap, easy to manufacture, moderate CTE.

The G-CLEF bench will be made out of Carbon Reinforced Fiber Polymer* (CFRP) – expensive, tricky to fabricate, among the lowest CTE structural materials available.

*An organic material.

An Example of Issues That Wake a Priincipal Investigator Up at 3 am.*

*With Heartburn.



Bluer – Less full Redder – more full

Red field lines: charge present

Black field lines: no charge present



Electric fields in CCD are inhomogeous and anisotropic due to:

- "Tree Rings" due to imperfect doping of the silicon boule wafers are diced from.
- "Glowing edges" due to larger field structures at CCD periphery.
- Tape bumps due to attachment technology for back-side (thinned) CCDs.

Electric field anisotropies distort the pixel grid.

These distortions are not regular or easily characterized.





